

Discription

The SRV05-4D is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail.A zener diode is integrated in to the array between the positive and negative supply rails.In the typical applications, the negative rail pin

(assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.

Features

- ★ 5 channels of ESD protection
- ★ Provides ESD protection IEC61000-4-2 level 4 - ±27kV air discharge
 - ±15kV contact discharge
- ★ Channel I/O to GND capacitance: 0.4pF(Max)
- ★ Channel I/O to I/O capacitance: 0.8pF(Max)
- ★ Low clampingvoltage
- ★ Low operating voltage
- ★ Improved zener structure
- Optimized package for easyhigh speed data lines PCB layout
- ★ RoHS compliant.

Orderingin formation

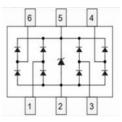
Product ID	Pack	Qty(PCS)
SRV05-4D	SOT-23-6L	3000

Absolute Ratings(Tamb = 25°C)

Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20µs)	P _{PP}	55	W
Peak Pulse Current(8/20µs)	IPP	4	А
ESD per IEC 61000-4-2(Air)	V_{ESD1}	±20kV	kV
ESD per IEC 61000-4-2(Contact)	V _{ESD2}	±15kV	kV
Operating Temperature Range	Topr	-55 ~ +125	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C







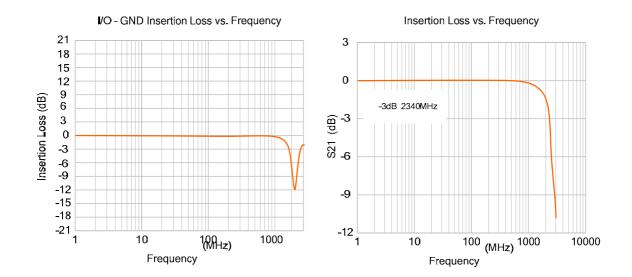
Circuit Diagram

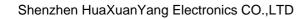


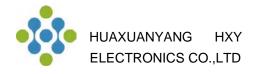
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Reverse Working Voltage	V _{RWM}	Any I/O pin to GND			5	V
Reverse Breakdown Voltage	V _{BR}	I t=1mA; Any I/O pin to GND	6			V
Reverse Leakage Current	I _R	V _{RWM} =5V, T=25°C; Any I/O pin to GND			1	μA
Positive Clamping Voltage	V _{C1}	I _{PP} =4A, t _P =8/20 µs; Positive pulse; Any I/O pin to GND		8.5	12.0	V
Negative Clamping Voltage	V _{C2}	I _{PP} =4A, t _P =8/20µs; Negative pulse; Any I/O pin to GND		1.8		V
Junction Capacitance Between Channel	C _{J1}	V _R =0V, f=1MHz; Between I/O pins		0.3	0.4	pF
Junction Capacitance Between I/O And GND	C _{J2}	V _R =0V, f=1MHz; Any I/O pin to GND		0.6	0.8	pF

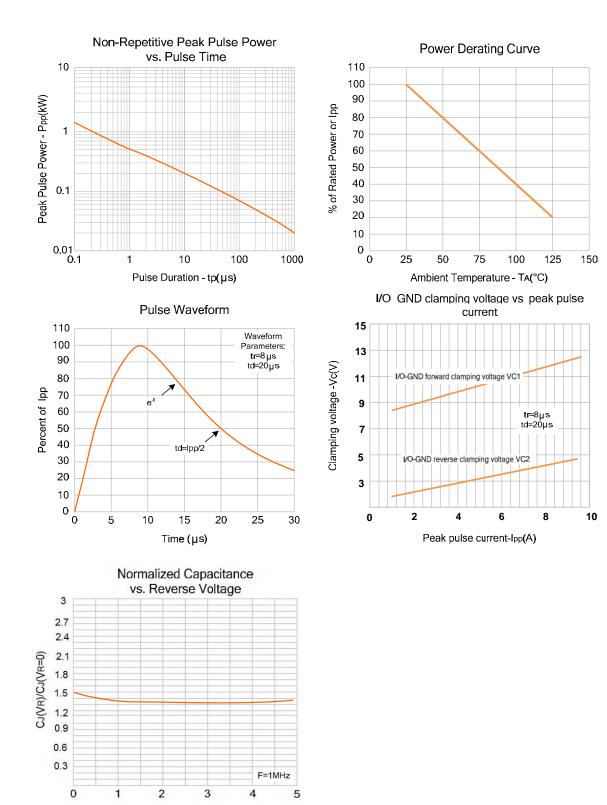
Electrical Characteristics (Tamb=25°C)

Typical Characteristics





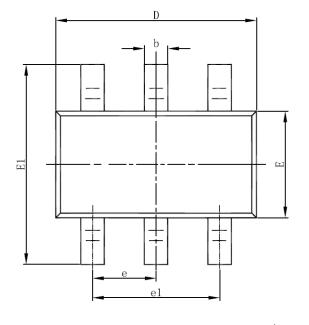


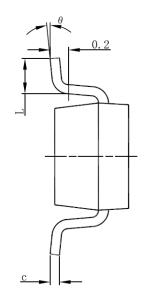


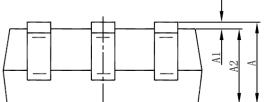
Reverse Voltage - VR(V)



SOT-23-6L Package Information







Sumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950	(BSC)	0.037	0.037(BSC)	
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



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